HALL-ADAPTER-EVM Usage Instructions
The HALL-ADAPTER-EVM simplifies prototyping SMT ICs:

The HALL-ADAPTER-EVM supports SOT23-3 (DBZ), TO-92 (LPG), X2SON (DMR), SOT23-5/6 (DBV), DSBGA (YBH) and MSOP-8 (DGK) packages.

Usage Instructions:

Step 1: Solder IC(s) to adapter PCB. Parts may be hand soldered or attached with IR or hot air reflow techniques.

Step 2: Use long nose pliers to snap terminal strips (Samtec part number TSW-124-07-L-S) into 4 position lengths.
Step 3: Gently flex panel at score lines to separate boards.

Step 4: Insert terminal strips into a breadboard or spare DIP socket to align pins.

Step 5: Position board over pins and solder the connections. Carefully remove from breadboard or DIP socket and complete.
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<th>Changes from Original (November 2017) to A Revision</th>
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<td>• Changed <em>Usage Instructions</em> format to follow other ADAPTER-EVM guides.</td>
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